

Certificate of Conformance

Customer:
Customer Part#:
Customer PO#:
LOT#: 6PO-UT2371/DSP255
Growing Method: CZ
Type: P-type
Dopant: Boron
Diameter: 150+/-0.2 mm
Thickness: 255+/-10 µm
Resistivity: >1 Ωcm
Front Side: Polished (roughness <1nm rms)
Back Side: Polished (roughness <1nm rms)
Orientation: (100) +/-1 deg
Primary Flat: none
Secondary Flat: none
Surface Particle: <=10pcs a>=0.3um by visual inspection
Bow: <30 µm
Warp: <30 µm
TTV (GBIR): <5 µm

Lot No.	QTY	Bow/Warp	TTV	Thickness
6PO- UT2371/DSP255	50	5	1	257
		2	2	255
		3	1	254

Date:

Signature: